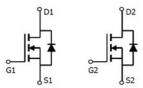




N-Channel Power MOSFET

Description

The RMD8N60S8 uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.



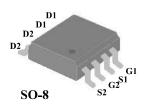
General Features

• $V_{DS} = 60V, I_{D} = 8A$

$$\begin{split} R_{DS(ON)} &< 20 m \Omega \text{ @ } V_{GS} \text{=} 10 V \quad \text{(Typ:15m} \Omega\text{)} \\ R_{DS(ON)} &< 25 m \Omega \text{ @ } V_{GS} \text{=} 4.5 V \quad \text{(Typ:19.5m} \Omega\text{)} \end{split}$$

- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Low gate to drain charge to reduce switching losses

Schematic diagram



pin assignment

Application

- Power switching application
- Load switch
- Halogen-free

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
4846	RMD8N60S8	SOP-8			

Absolute Maximum Ratings (T_C=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	60	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	I _D	8	A
Drain Current-Continuous(T _C =100°ℂ)	I _D (100℃)	6.5	Α
Pulsed Drain Current	I _{DM}	32	Α
Maximum Power Dissipation	P _D	1.5	W
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55 To 150	$^{\circ}$

Thermal Characteristic

Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{ heta JA}$	85	°C/W

Electrical Characteristics (TC=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	60		-	V
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} =60V, V_{GS} =0V	-	-	1	μΑ
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)			•			
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	1.2	1.8	2.2	V
Dunin Course On State Presistance		V _{GS} =10V, I _D =7A	-	15	20	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =5A	-	19.5	25	mΩ
Forward Transconductance	g Fs	V _{DS} =5V,I _D =9A	25	-	-	S
Dynamic Characteristics (Note4)			•			
Input Capacitance	C _{Iss}	\/ -20\/\/ -0\/	-	2180	-	PF
Output Capacitance	Coss	$V_{DS}=30V, V_{GS}=0V,$	-	350	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	270	-	PF
Switching Characteristics (Note 4)			•			
Turn-on Delay Time	t _{d(on)}		-	8.5	-	nS
Turn-on Rise Time	t _r	V_{DD} =30V, R_L =1 Ω	-	6	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10 V , R_{GEN} =3 Ω	-	30	-	nS
Turn-Off Fall Time	t _f		-	5	-	nS
Total Gate Charge	Qg	V -20VI -0A	-	58	-	nC
Gate-Source Charge	Q _{gs}	V_{DS} =30V, I_{D} =8A, V_{GS} =10V	-	8	-	nC
Gate-Drain Charge	Q_{gd}	V _{GS} =10V	-	17	-	nC
Drain-Source Diode Characteristics			•			
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =9A	-	-	1.2	V
Diode Forward Current (Note 2)	Is	-	-	-	7	Α
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF=9A	-	30	-	nS
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$	-	44	-	nC

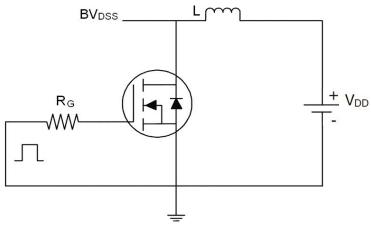
Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- 3. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production

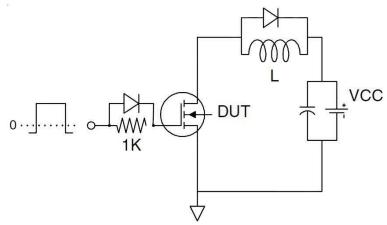


Test Circuit

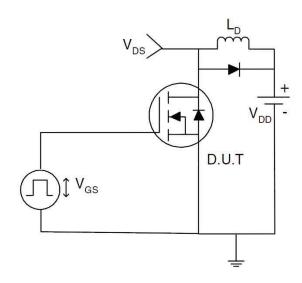
1) E_{AS} test Circuit



2) Gate charge test Circuit



3) Switch Time Test Circuit





RATING AND CHARACTERISTICS CURVES (RMD8N60S8)

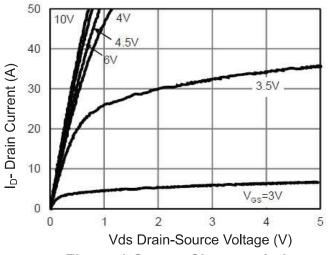


Figure 1 Output Characteristics

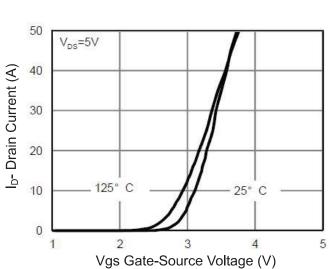


Figure 2 Transfer Characteristics

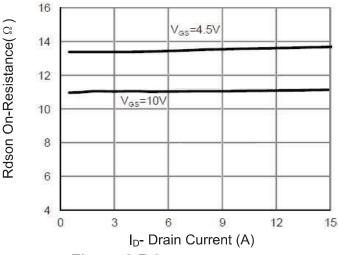


Figure 3 Rdson- Drain Current

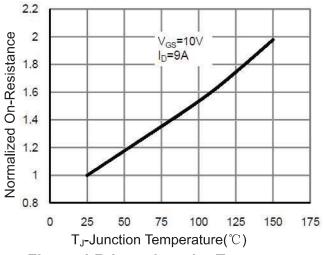


Figure 4 Rdson-JunctionTemperature

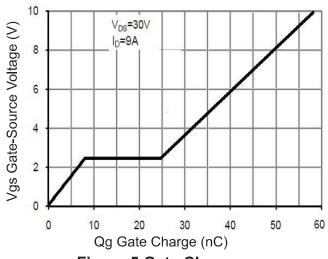


Figure 5 Gate Charge

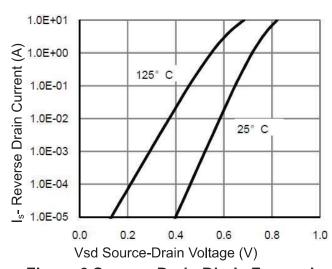
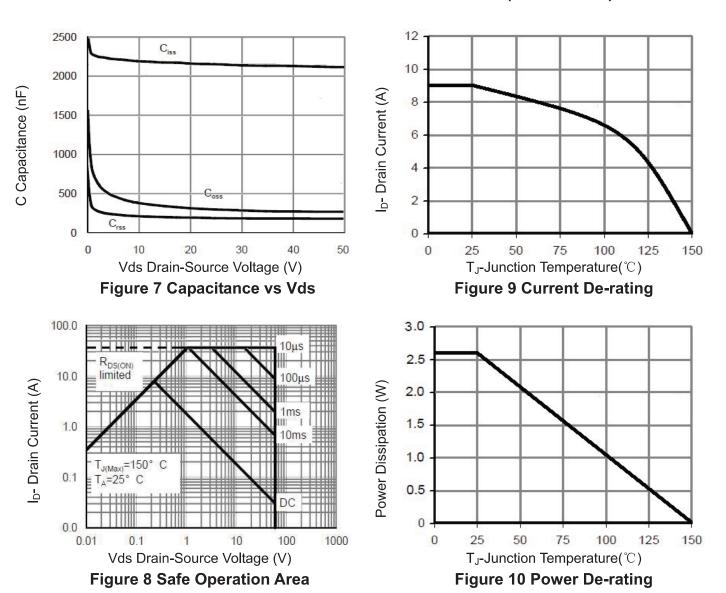
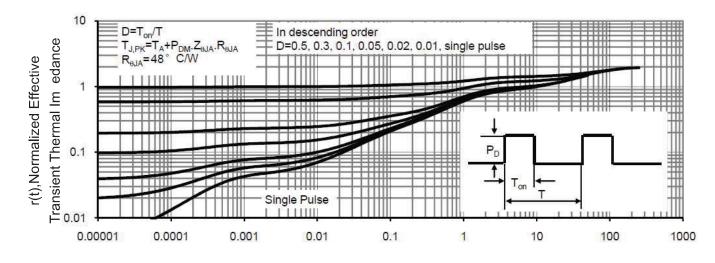


Figure 6 Source- Drain Diode Forward



RATING AND CHARACTERISTICS CURVES (RMD8N60S8)



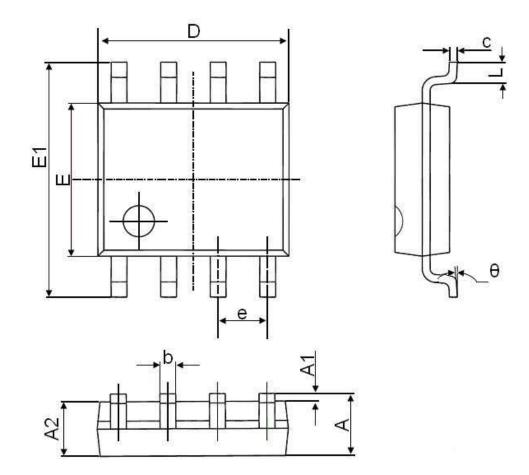


Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance



SOP-8 Package Information



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α	1.350	1.750	0.053	0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
С	0.170	0.250	0.006	0.010	
D	4.700	5.100	0.185	0.200	
E	3.800	4.000	0.150	0.157	
E1	5.800	6.200	0.228	0.244	
е	1.270(BSC)		0.050(BSC)		
L	0.400	1.270	0.016	0.050	
θ	0°	8°	0°	8°	

